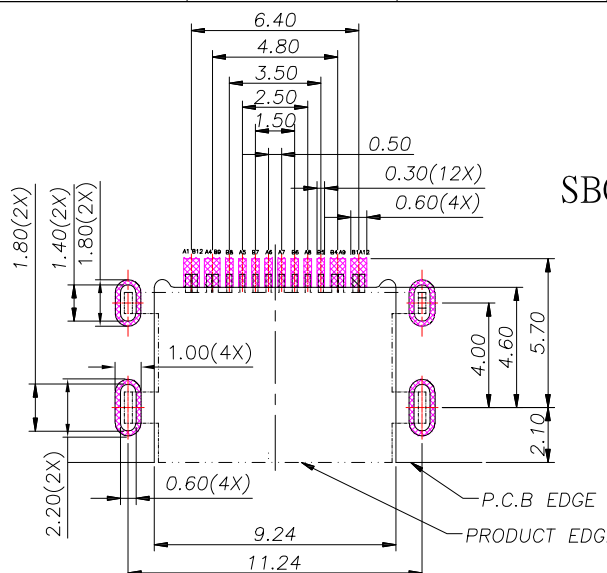
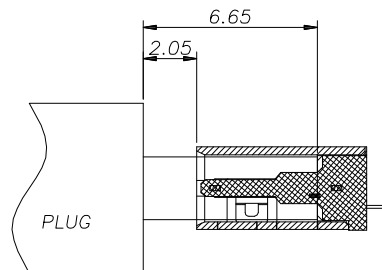
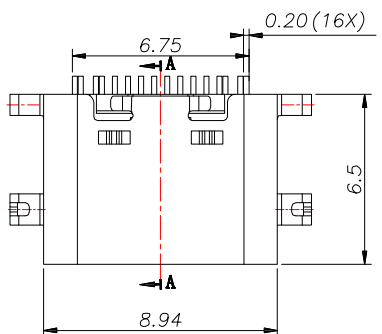




SBC-160M3A-20x-S412

鍍層厚度:

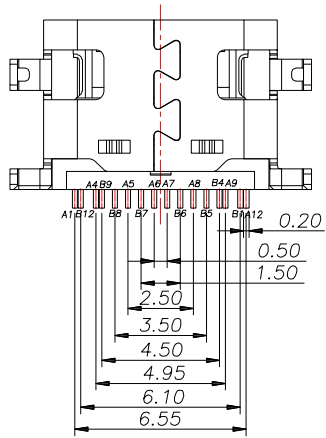
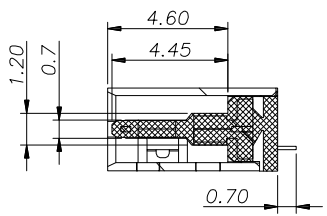
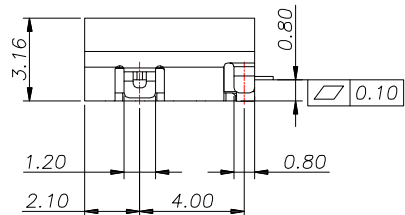
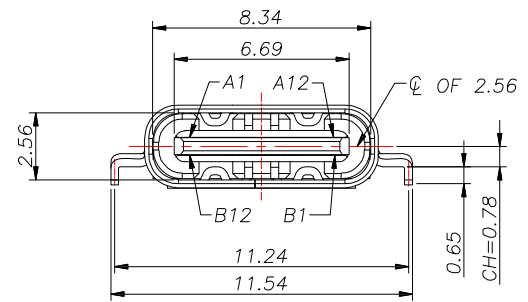
Blank : 1u"
1 : 3u"
2 : 15u"
3 : 30u"



RECOMMENDED PCB LAYOUT

USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND



SPECIFICATIONS

Electrical:

- 1.Rating: 5.0V , 3.0 A
- 2.Contact Resistance: 40 mΩ Max
- 3.Insulation Resistance: 100 MΩ Min

Mechanical:

- 1.Connector Mate and Unmate Force
 - 1.1 Mate force: 5~20 N
 - 1.2 Unmate force: 8~20 N

Material:

- 1.Housing: LCP
- 2.Contact: C7025
- 3.Shell: SUS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



TOLERANCE UNLESS OTHERWISE STATED:
 Up to 5 ±0.2
 Above 5 ~ 15 ±0.3
 Above 15 ~ 30 ±0.4
 Above 30 ~ 50 ±0.5
 Angle ±0.3°

3RD. ANGEL'S



UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	11/16/22			
CHECKED BY:	DATE	FINISH	MODLE	USB TYPE C 2.0 沉板 0.8mm
Jacky Chen	11/16/22			
APPROVED BY:	DATE	SCALE	DWG NO.	SBC-160M3A-20x-S412
Tony Kao	11/16/22	1 : 1	PART NO.	SBC-160M3A-20x-S412
		SHEET NO.	1 of 1	
			SIZE	A4
			VER	R3

ITEM NO	DESCRIPTION	DRAWN	DATE
3	更新Contact材質	Jack	111622
2	新增鍍層厚度選項	Jack	121120
1	新增PCB LAYOUT尺寸	Jack	120220